

# NDBA180N10B

## Power MOSFET 100V, 2.8mΩ, 180A, N-Channel



ON Semiconductor®

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### Features

- Ultra Low On-Resistance
- Low Gate Charge
- High Speed Switching
- 100% Avalanche Tested
- Pb-Free, Halogen Free and RoHS compliance

### Specifications

Absolute Maximum Ratings at Ta = 25°C (Note 1)

Parameter	Symbol	Value	Unit
Drain to Source Voltage	V <sub>DSS</sub>	100	V
Gate to Source Voltage	V <sub>GSS</sub>	±20	V
Drain Current (DC)	I <sub>D</sub>	180	A
Drain Current (DC) Limited by Package	I <sub>DL</sub>	100	A
Drain Current (Pulse) PW≤10μs, duty cycle≤1%	I <sub>DP</sub>	600	A
Power Dissipation Tc=25°C	P <sub>D</sub>	200	W
Junction Temperature	T <sub>j</sub>	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to +175	°C
Source Current (Body Diode)	I <sub>S</sub>	100	A
Avalanche Energy (Single Pulse) (Note 2)	E <sub>AS</sub>	451	mJ
Lead Temperature for Soldering Purposes, 3mm from Case for 10 Seconds	T <sub>L</sub>	260	°C

Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2 : V<sub>DD</sub>=48V, L=100μH, I<sub>AV</sub>=70A (Fig.1)

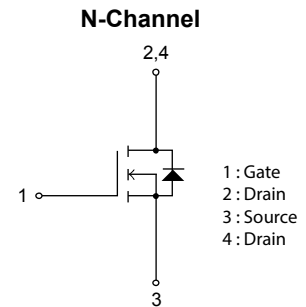
### Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to Case Steady State	R <sub>θJC</sub>	0.75	°C/W
Junction to Ambient (Note 3)	R <sub>θJA</sub>	62.5	

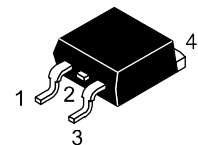
Note 3 : Surface mounted on FR4 board using recommended footprint

V <sub>DSS</sub>	R <sub>DS(on)</sub> Max	I <sub>D</sub> Max
100V	2.8mΩ@ 15V	180A
	3.3mΩ@ 10V	

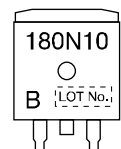
### Electrical Connection



### Marking



TO-263  
CASE 418AJ



### ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

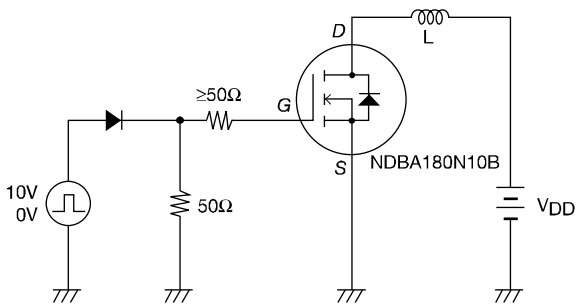
# NDBA180N10B

## Electrical Characteristics at Ta = 25°C (Note 4)

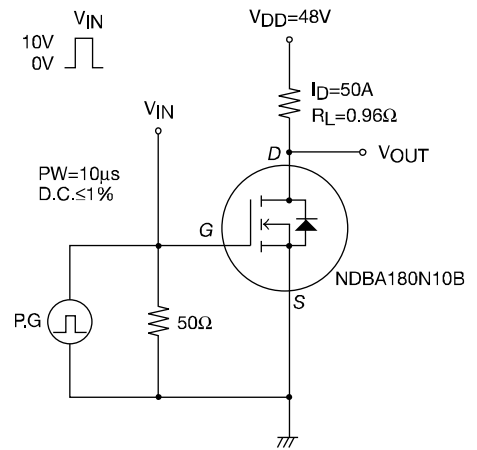
Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=10mA, V_{GS}=0V$	100			V
Zero-Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=100V, V_{GS}=0V$			10	$\mu A$
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 200$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=10V, I_D=1mA$	2		4	V
Forward Transconductance	gFS	$V_{DS}=10V, I_D=50A$		150		S
Static Drain to Source On-State Resistance	$R_{DS(on)1}$	$I_D=50A, V_{GS}=15V$		2.3	2.8	$m\Omega$
	$R_{DS(on)2}$	$I_D=50A, V_{GS}=10V$		2.5	3.3	$m\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=50V, f=1MHz$		6,950		pF
Output Capacitance	$C_{oss}$			3,000		pF
Reverse Transfer Capacitance	$C_{rss}$			15		pF
Turn-ON Delay Time	$t_{d(on)}$	See Fig.2		95		ns
Rise Time	$t_r$			320		ns
Turn-OFF Delay Time	$t_{d(off)}$			185		ns
Fall Time	$t_f$			130		ns
Total Gate Charge	Qg	$V_{DS}=48V, V_{GS}=10V, I_D=100A$		95		nC
Gate to Source Charge	Qgs			31		nC
Gate to Drain "Miller" Charge	Qgd			26		nC
Forward Diode Voltage	$V_{SD}$	$I_S=100A, V_{GS}=0V$		0.9	1.5	V
Reverse Recovery Time	$t_{rr}$	See Fig.3		150		ns
Reverse Recovery Charge	Qrr	$I_S=100A, V_{GS}=0V, V_{DD}=50V, di/dt=100A/\mu s$		580		nC
Reverse Recovery Charge	Qrr	$I_S=100A, V_{GS}=0V, V_{DD}=50V, di/dt=100A/\mu s$		580		nC

Note 4 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

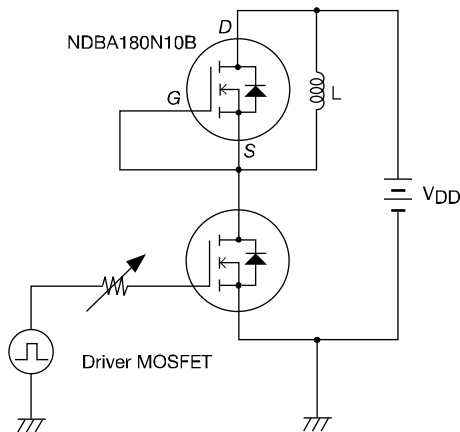
**Fig.1 Unclamped Inductive Switching Test Circuit**



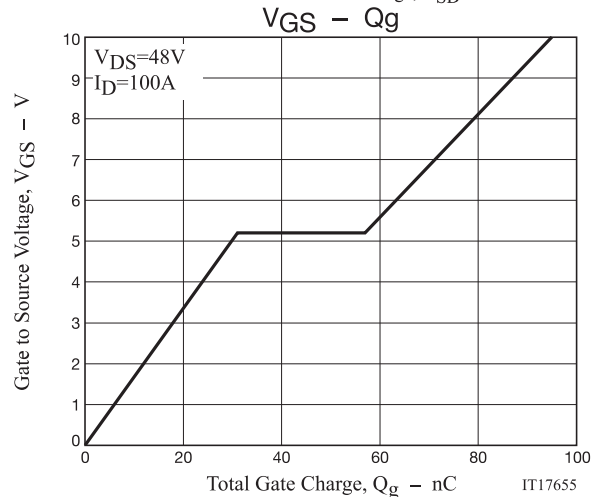
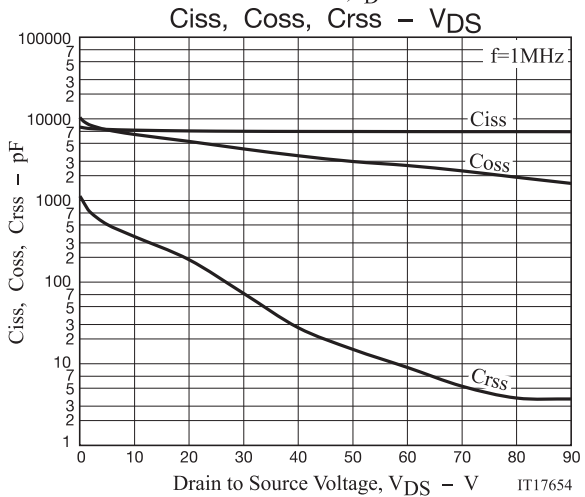
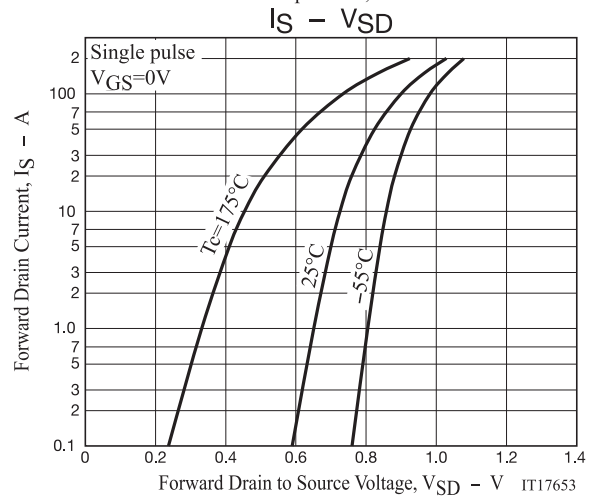
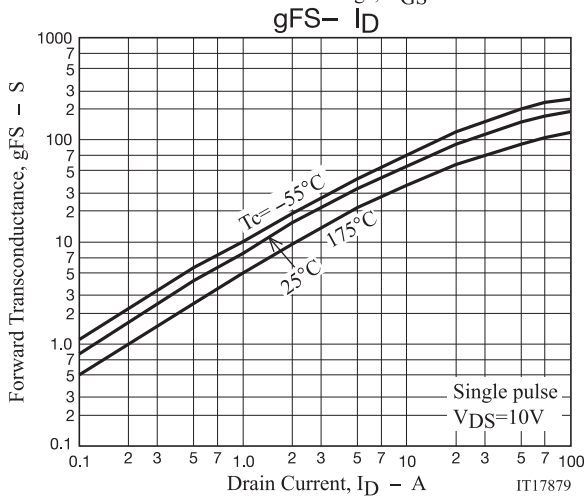
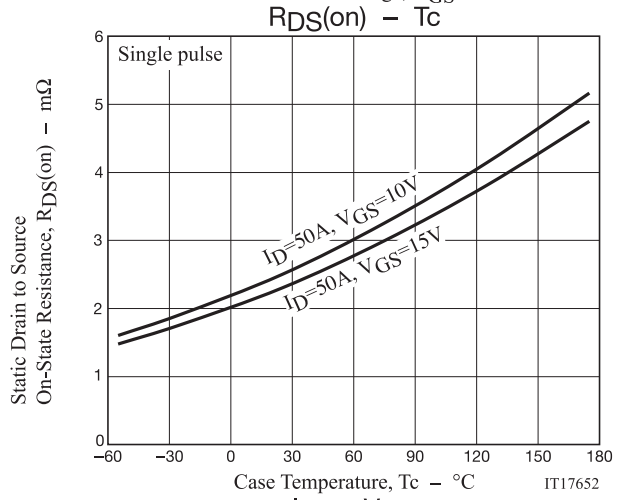
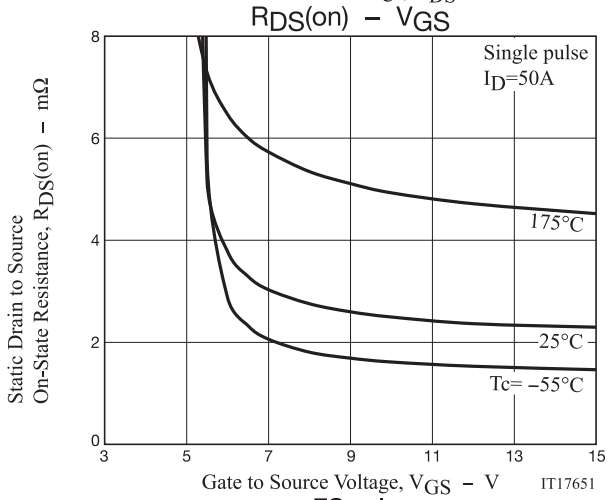
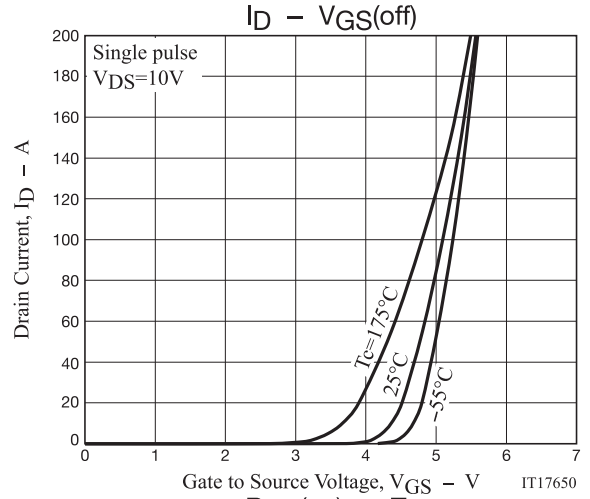
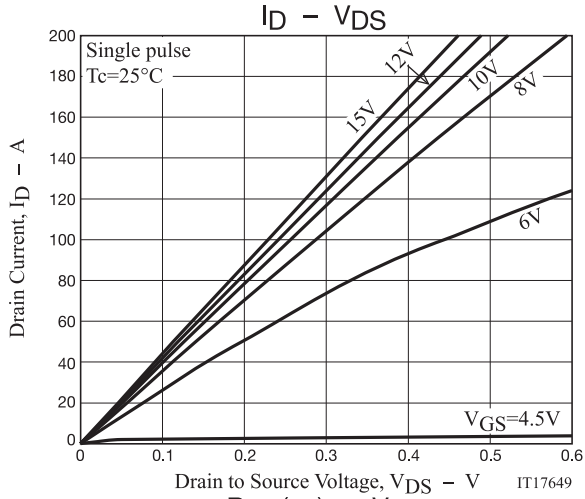
**Fig.2 Switching Time Test Circuit**



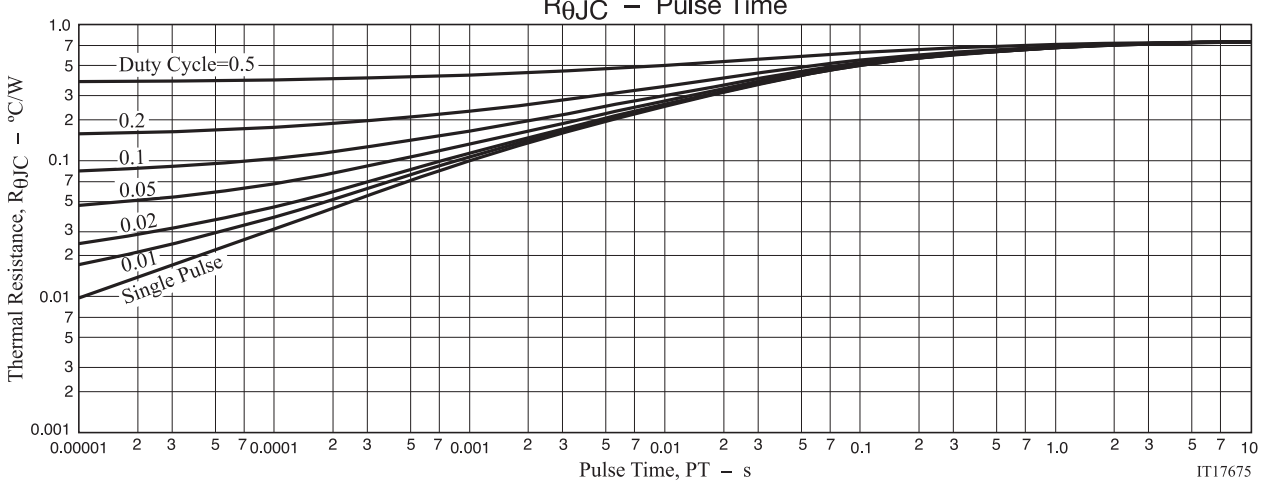
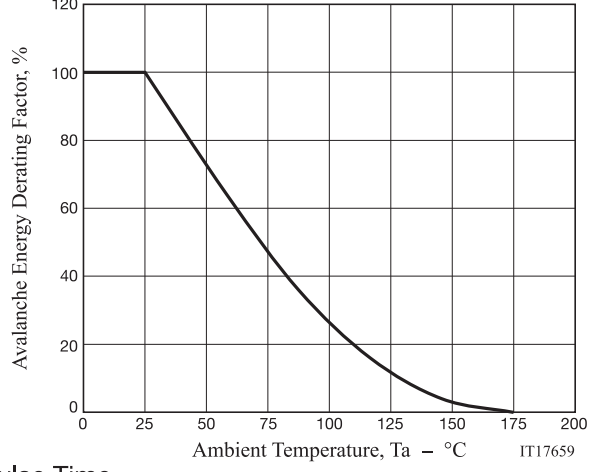
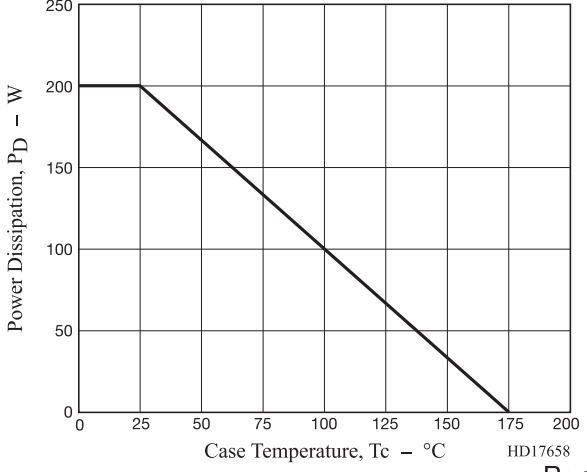
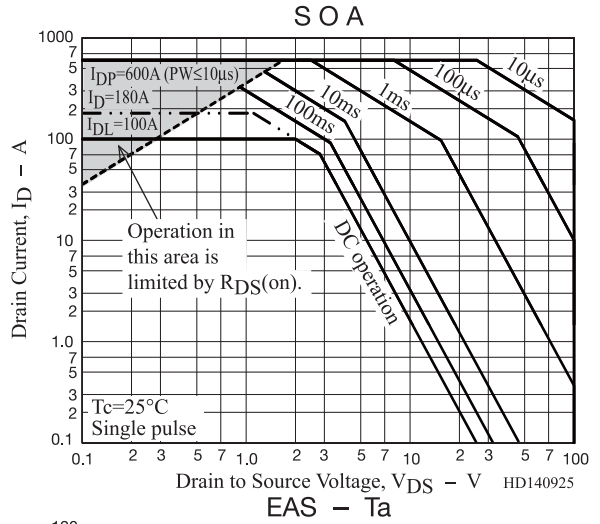
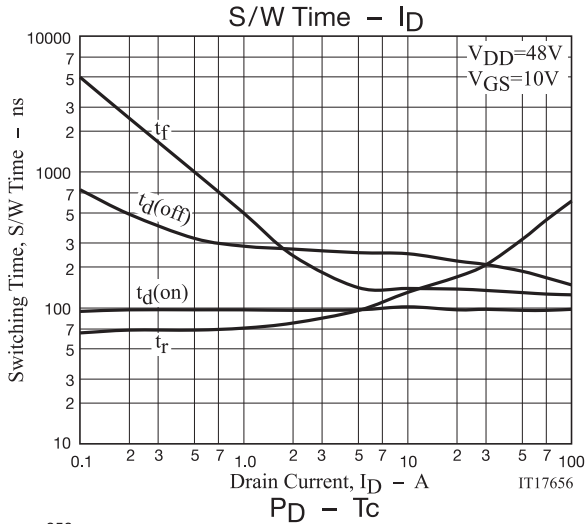
**Fig.3 Reverse Recovery Time Test Circuit**



# NDBA180N10B



# NDBA180N10B

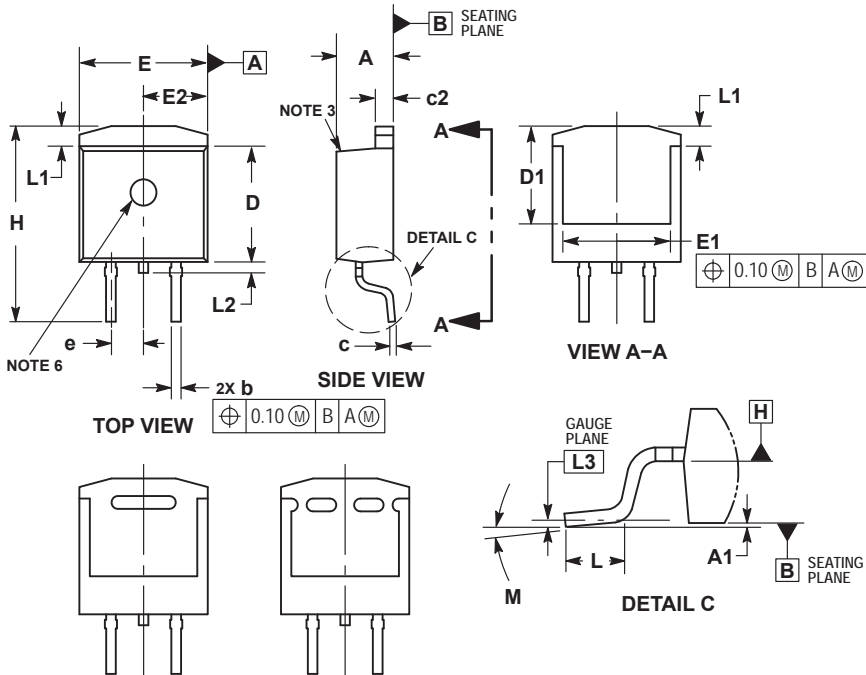


# NDBA180N10B

## Package Dimensions

unit : mm

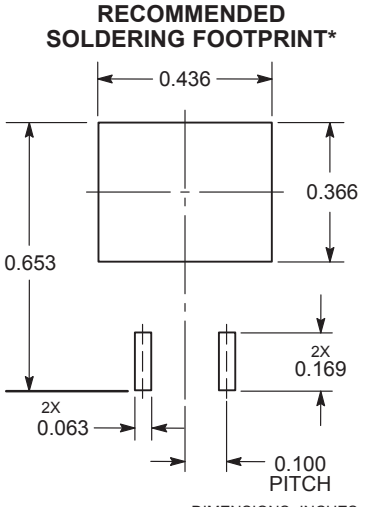
D<sup>2</sup>PAK-3 (TO-263, 3-LEAD)  
CASE 418AJ  
ISSUE B



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: INCHES.
  3. CHAMFER OPTIONAL
  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
  5. THERMAL PAD CONTOUR IS OPTIONAL WITHIN DIMENSIONS E, L1, D1 AND E1.
  6. OPTIONAL MOLD FEATURE

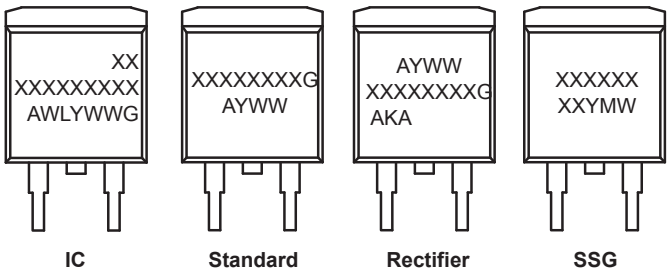
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.160	0.190	4.06	4.83
A1	0.000	0.010	0.00	0.25
b	0.020	0.039	0.51	0.99
c	0.012	0.029	0.30	0.74
c2	0.045	0.065	1.14	1.65
D	0.330	0.380	8.38	9.65
D1	0.260	---	6.60	---
E	0.380	0.420	9.65	10.67
E1	0.245	---	6.22	---
e	0.100 BSC	---	2.54 BSC	---
H	0.575	0.625	14.60	15.88
L	0.070	0.110	1.78	2.79
L1	---	0.066	---	1.68
L2	---	0.070	---	1.78
L3	0.010 BSC	---	0.25 BSC	---
M	0°	8°	0°	8°

VIEW A-A  
OPTIONAL CONSTRUCTIONS



DIMENSIONS: INCHES

### GENERIC MARKING DIAGRAMS\*



- XXXXXX = Specific Device Code
- A = Assembly Location
- WL = Wafer Lot
- Y = Year
- WW = Work Week
- W = Week Code (SSG)
- M = Month Code (SSG)
- G = Pb-Free Package
- AKA = Polarity Indicator

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "μ", may or may not be present.

# NDBA180N10B

## ORDERING INFORMATION

Device	Package	Shipping	Note
NDBA180N10BT4H	D <sup>2</sup> PAK-3 (TO-263, 3-LEAD)	800 pcs. / Tape & Reel	Pb-Free and Halogen Free

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. [http://www.onsemi.com/pub\\_link/Collateral/BRD8011-D.PDF](http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF)

Note on usage : Since the NDBA180N10B is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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